



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

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Small switching (60V, 2A)

2SK2094

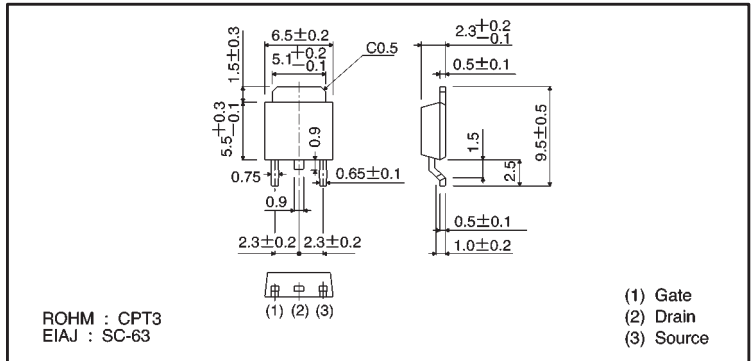
●Features

- 1) Low on-resistance.
- 2) Fast switchig speed.
- 3) Wide SOA (safe operating area).
- 4) Low-voltage drive (4V).
- 5) Easily designed drive circuits.
- 6) Easy to parallel.

●Structure

Silicon N-channel
MOSFET

●External dimensions (Units: mm)



●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit	
Drain-source voltage	V _{DSS}	60	V	
Gate-source voltage	V _{GSS}	±20	V	
Drain current	Continuous	I _D	2	A
	Pulsed	I _{DP} *	8	A
Reverse drain current	Continuous	I _{DR}	2	A
	Pulsed	I _{DRP} *	8	A
Total power dissipation(Tc=25°C)	P _D	20	W	
Channel temperature	T _{ch}	150	°C	
Storage temperature	T _{stg}	-55~+150	°C	

* Pw≤300 μs, Duty cycle≤2%

●Packaging specifications

Type	Package	Taping
	Code	TL
	Basic ordering unit (pieces)	2500
2SK2094		○

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Gate-source leakage	I_{GSS}	—	—	± 100	nA	$V_{GS}=\pm 20V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D=1mA, V_{GS}=0V$
Zero gate voltage drain current	I_{DSS}	—	—	100	μA	$V_{DS}=60V, V_{GS}=0V$
Gate threshold voltage	$V_{GS(th)}$	1.0	—	2.5	V	$V_{DS}=10V, I_D=1mA$
Static drain-source on-state resistance	$R_{DS(on)}$	—	0.3	0.35	Ω	$I_D=1A, V_{GS}=10V$
		—	0.4	0.5		$I_D=1A, V_{GS}=4V$
Forward transfer admittance	$ Y_{fs} $	1.0	—	—	S	$V_{DS}=10V, I_D=1A$
Input capacitance	C_{iss}	—	400	—	pF	$V_{DS}=10V$
Output capacitance	C_{oss}	—	150	—	pF	$V_{GS}=0V$
Reverse transfer capacitance	C_{rss}	—	50	—	pF	$f=1MHz$
Turn-on delay time	$t_{d(on)}$	—	10	—	ns	$I_D=1A, V_{DD}\doteq 30V$
Rise time	t_r	—	20	—	ns	$V_{GS}=10V$
Turn-off delay time	$t_{d(off)}$	—	100	—	ns	$R_L=30\Omega$
Fall time	t_f	—	40	—	ns	$R_G=10\Omega$
Reverse recovery time	t_{rr}	—	100	—	ns	$I_{DR}=2A, V_{GS}=0V, di/dt=50A/\mu s$

●Electrical characteristic curves

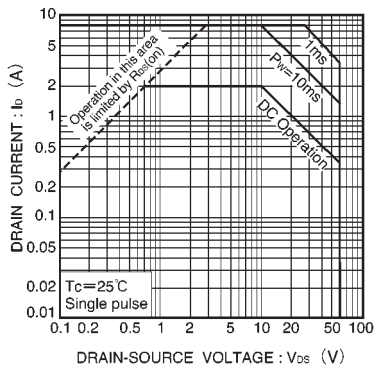


Fig.1 Maximum safe operating area

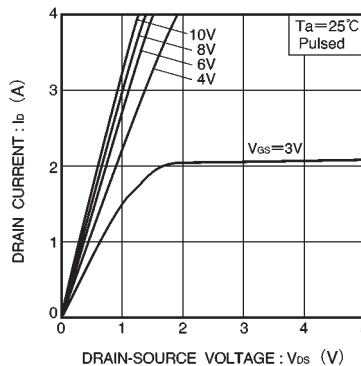


Fig.2 Typical output characteristics

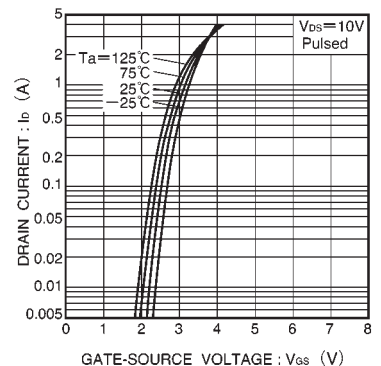


Fig.3 Typical transfer characteristics

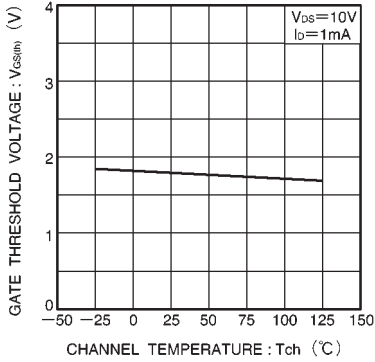


Fig.4 Gate threshold voltage vs. channel temperature

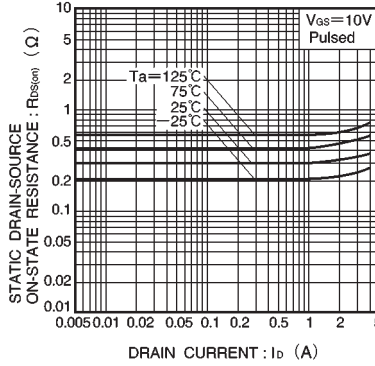


Fig.5 Static drain-source on-state resistance vs. drain current (I)

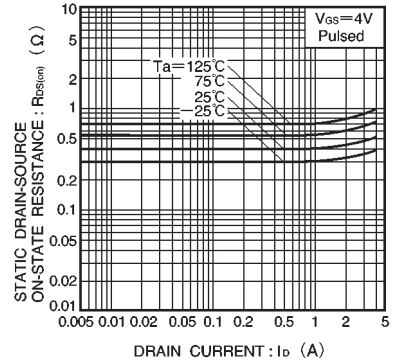


Fig.6 Static drain-source on-state resistance vs. drain current (II)

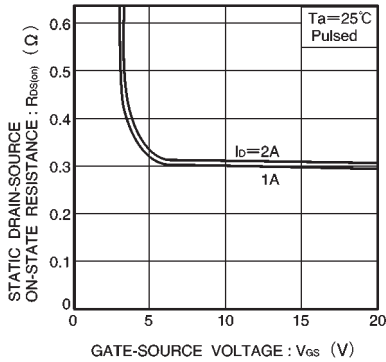


Fig.7 Static drain-source on-state resistance vs. gate-source voltage

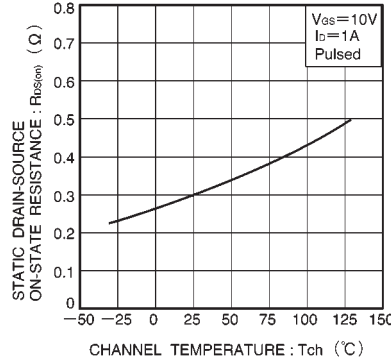


Fig.8 Static drain-source on-state resistance vs. channel temperature

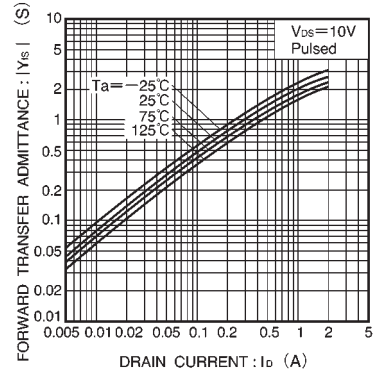


Fig.9 Forward transfer admittance vs. drain current

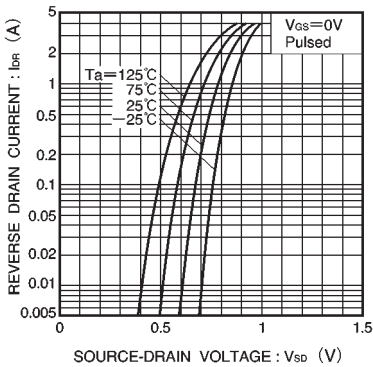


Fig.10 Reverse drain current vs. source-drain voltage (I)

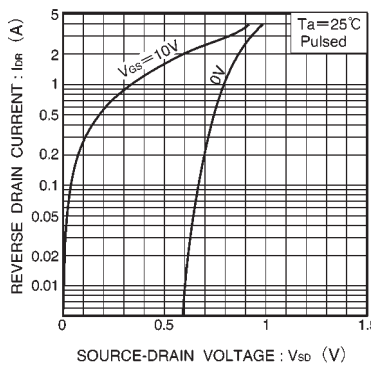


Fig.11 Reverse drain current vs. source-drain voltage (II)

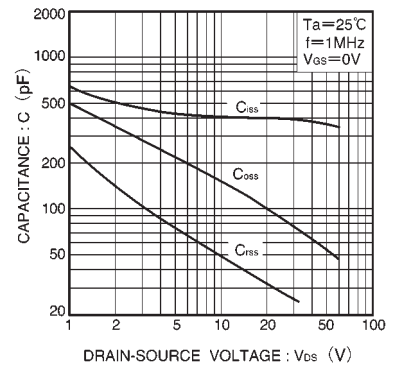


Fig.12 Typical capacitance vs. drain-source voltage

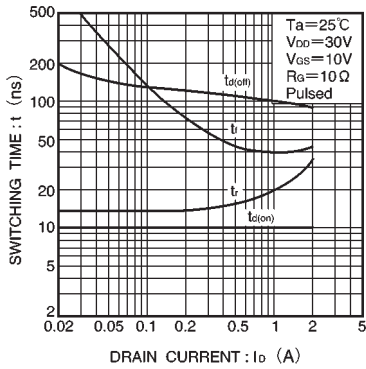


Fig.13 Switching characteristics (See Figure. 15 and 16 for the measurement circuit and resultant waveforms)

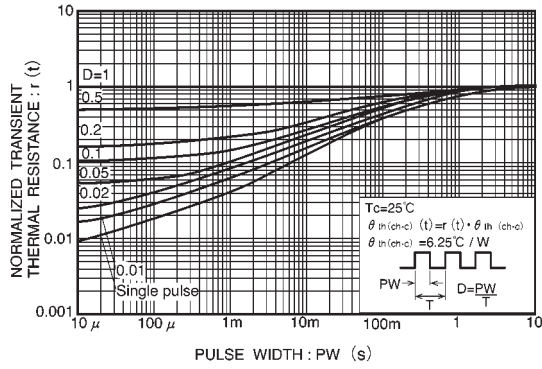


Fig.14 Normalized transient thermal resistance vs. pulse width

● Switching characteristics measurement circuit

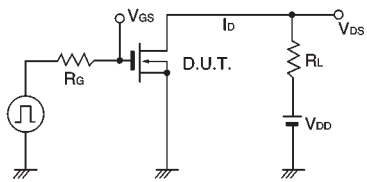


Fig.15 Switching time measurement circuit

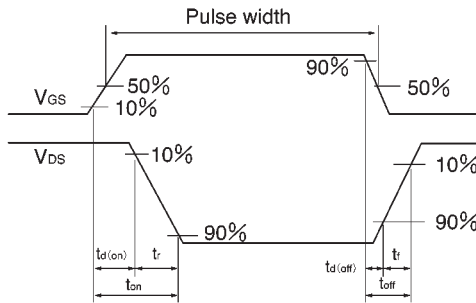


Fig.16 Switching time waveforms

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